Product Change Notification - JAON-08BVJU876 - 13 Jan 2016 - CCB 1835 Initial Notic... Page 1 of 2

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PRODUCTS APPL	ICATIONS DESIGN	I SUPF	PORT	TR/	INING	SA	MPLE	E & BI	UY	ABOUT	US	Conta	act Us	my№	licroch	iip Login
Product Change	Notification - JAON	-08BV	'JU87	'6 (Pr	nter Frie	endly)										
Date:	13 Jan 2016															
Notification subject:	CCB 1835 Initial Notice: technology available in 8						with gol	ld flash	(CuPd	Au) bond w	ire in se	lected p	oroduct	s of th	e 200K	wafer
Notification text:	PCN Status: Initial notification															
		Microchip Parts Affected: Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CPN.														
	NOTE: For your conve	NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).														
	Description of Chang Qualification of palladi technology available in	um coa						bond	wire ir	selected	product	s of the	e 200k	( wafe	۱	
	<b>Pre Change:</b> Gold (Au) or Palladiun	n coated	d coppe	r wire (	PdCu) b	ond wi	re									
	Post Change: Palladium coated cop	per with	gold fla	ash (Cu	PdAu) b	ond wi	re									
	Pre and Post Change															
							Pre Change					Post Change				
	Assem	Assembly Site Wire material				MMT assembly site					MMT assembly site					
	Wire r					Au w	ire or F	PdCu w	vire		CuPdAu wire					
	Die attac	h mate	material			8390A					8390A					
	Molding con			pound material			G600V					G600V				
	Lead frame material					CDA194						CDA194				
	Impacts to Data She None	et:														
	Reason for Change: To improve manufacturability by qualifying Palladium coated copper with gold flash (CuPdAu) bond wire.															
	i o improve manufactu	irability	by quai	inying i	anaulun	ooulo	u coppi		goiu		uAu) bu		e.			
	To improve manufactu Change Implementat In Progress	-		ilying i	anadiun	locato			goiu		uAu) bi		е.			
	Change Implementat	ion Sta Date:	tus:	inyinig t		locato			goid		unu) bi		e.			
	Change Implementat In Progress Estimated First Ship	ion Sta Date: ode: 16	<b>tus:</b> 16)											e part	s.	
	Change Implementat In Progress Estimated First Ship April 20, 2016 (date co	ion Sta Date: ode: 16	<b>tus:</b> 16)											e part	S.	
	Change Implementation In Progress Estimated First Ship April 20, 2016 (date con NOTE: Please be add	<b>Date:</b> Date: 16 <sup>2</sup> vised that	<b>tus:</b> 16)	the esti	nated fi	rst ship		custom			pre and		chang		s. 2016	
	Change Implementation In Progress Estimated First Ship April 20, 2016 (date con NOTE: Please be add	ion Sta Date: ode: 16 <sup>2</sup> vised tha	tus: 16) at after nuary 2	the esti	nated fi	rst ship	o date c	custom		ay receive	pre and		chang			17

Markings to Distinguish Revised from Unrevised Devices: Traceability code Х

Х

Х

Qual Report

Implementation

Availability Final PCN Issue

Date

Date

Revision History: January 13, 2016: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN\_JAON-08BVJU876\_Qual\_Plan.pdf PCN\_JAON-08BVJU876\_Affected\_CPN.pdf PCN\_JAON-08BVJU876\_Affected\_CPN.xls

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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